

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
ZHIGUANG DING	03/09/2020
ZILI LIU	03/09/2020
XIQIN LIU	03/09/2020
BING YE	03/09/2020
WENJIANG DING	03/09/2020
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	FENGYANG AIERSI LIGHT ALLOY PRECISION MOLDING CO., LTD.
<b>Street Address:</b>	R & D DEPARTMENT, MENTAI INDUSTRIAL PARK
<b>Internal Address:</b>	FENGYANG COUNTY
<b>City:</b>	CHUZHOU, ANHUI
<b>State/Country:</b>	CHINA
<b>Postal Code:</b>	233100
<b>Name:</b>	SHANGHAI JIAOTONG UNIVERSITY
<b>Street Address:</b>	COLLEGE OF MATERIALS,
<b>Internal Address:</b>	1954 HUASHAN ROAD
<b>City:</b>	SHANGHAI
<b>State/Country:</b>	CHINA
<b>Postal Code:</b>	200240
<b>Name:</b>	NANJING UNIVERSITY OF AERONAUTICS AND ASTRONAUTICS
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<b>Postal Code:</b>	210016
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	16753572
<b>CORRESPONDENCE DATA</b>	

**Fax Number:** (330)535-1435

***Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.***

**Phone:** 330-535-2220

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**Correspondent Name:** HUDAK, SHUNK & FARINE CO. LPA

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<b>ATTORNEY DOCKET NUMBER:</b>	CNIP-II-PCT-US
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<b>NAME OF SUBMITTER:</b>	DANIEL J. HUDAK, JR.
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<b>SIGNATURE:</b>	/DHUDAKJR/
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<b>DATE SIGNED:</b>	04/03/2020
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**Total Attachments: 3**

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## **ASSIGNMENT**

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned by the Assignees,

**FENGYANG AIERSI LIGHT ALLOY PRECISION MOLDING CO., LTD.**  
a company organized under the laws of China, domiciled at  
**R & D Department, Mentai Industrial Park, Fengyang County, Chuzhou,**  
**Anhui 233100, China**

and

**SHANGHAI JIAOTONG UNIVERSITY**  
a university organized under the laws of China, domiciled at  
**College of Materials, 1954 Huashan Road, Shanghai 200240, China**

and

**NANJING UNIVERSITY OF AERONAUTICS AND ASTRONAUTICS**  
a university organized under the laws of China, domiciled at  
**College of Materials, 29 Yudao Street, Qinhuai District, Nanjing,**  
**Jiangsu 210016, China**

receipt whereof is hereby acknowledged, the undersigned by these presents hereby sells, assigns, transfers, and sets over unto said Assignees the entire right, title and interest in and to the invention or improvement in

### **“MA-M<sub>2</sub>TSPINEL SOLID SOLUTION ENHANCED MAGNESIUM OXIDE-BASED CERAMIC FOAM FILTER AND PREPARATION METHOD THEREFOR”**

said invention being fully described and/or claimed in international application PCT/CN2018/089574 filed 06/01/2018, as well as any divisional, continuing, reissue, reexamination, or other patent applications, in and for the United States, the same to be held and enjoyed by said Assignees, their successors, assigns or other legal representatives, to the full ends of the terms for which all Letters Patent therefore may be granted, as fully and entirely as the same would have been held and enjoyed by the undersigned if this assignment and sale had not been made.

AND SAID ASSIGNEES ARE HEREBY AUTHORIZED to make application for and to receive Letters Patent for said invention in the United States at its election.

AND BY THIS COVENANT the undersigned will execute or procure any further necessary assurance of title to said invention and Letters Patent; and at any time, upon the request of said Assignees, will execute and deliver any and all papers that may be necessary or desirable to perfect the title to said invention or any Letters Patent which may be granted therefor to said Assignees, their successors, assigns or other legal representatives, and, upon the request of said Assignees, will execute any divisional, continuing, reissue, reexamination, or other applications for patents for said invention, in any country, and will make all rightful oaths and do all lawful acts requisite for aiding, procuring, or maintaining the same or for aiding therein.

AND THE COMMISSIONER of Patents is hereby authorized and requested to issue any and all Letters Patent to the United States for said invention, to said Assignees.

Assignment – Page 2

SIGNED as indicated adjacent our signatures.

Ding  
 Inventor Name: DING, Zhiguang  
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 Witnessed Zhu Lin  
 Name: ZHU, Lin  
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2020.3.9  
 Date

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 Date

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2020.3.9  
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 Date

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SIGNED as indicated adjacent our signatures.

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Witnessed Zhu Lin  
Name: ZHU, Lin  
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2020.3.9  
Date  
  
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